Spark Gap (SPG) Data Sheet

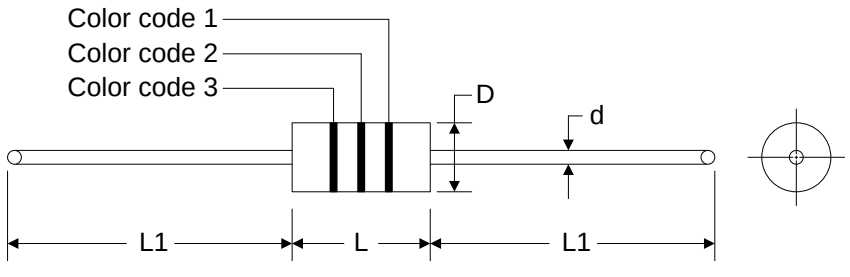
Features

- Approximately zero leaking current before clamping voltage
- Less decay at on/off state.
- High capability to withstand repeated lightning strikes.
- Low electrode capacitance(≤0.8pF) and high isolation(≥100MΩ).
- RoHS compliant.
- Bilateral symmetrical.
- Temperature, humidity and lightness insensitive.
- Operating temperature: -40℃ ~ +85℃
- Storage temperature: -40℃ ~ +125℃
- Meets MSL level 1, per J-STD-020
- Safety certification: UL: E244458

Applications

- Power Supplies
- Motor sparks eliminating
- Relay switching spark absorbing
- Data line pulse guarding
- Electronic devices requiring UL497A and UL497B compliant
- Telephone/Fax/Modem
- High frequency signal transmitters/receivers
- Satellite antenna
- Radio amplifiers
- Alarm systems
- Cathode ray tubes in Monitors/TVs

Dimensions



Symbol	Dimension (mm)
L	4.3±0.5
L1	28.0±3.0
D	Φ2.6±0.5
d	Φ0.5±0.05

Electrical Characteristics

Part Number ①	DC Spark-over Voltage	Minimum Insulation Resistance		Maximum Capacitance (1KHz-6V_{MAX})	Surge Current Capacity (8/20μs)	Surge Life Test
	Vs(V)	Test Voltage(V)	IR_{OHM}(MΩ)	C(pf)		8/20μs,100A
BK2XX00702	140	50	100	0.8	1000A	200 times
BK2XX01002	200	100	100	0.8	1000A	200 times
BK2XX01102	220	100	100	0.8	1000A	200 times
BK2XX01502	300	100	100	0.8	1000A	200 times
BK2XX02002	400	250	100	0.8	1000A	200 times
BK2XX02502	500	250	100	0.8	1000A	200 times
BK2XX03002	600	250	100	0.8	1000A	200 times
BK2XX03502	700	250	100	0.8	1000A	200 times
BK2XX05002	1000	500	100	0.8	1000A	200 times
BK2XX07502	1500	500	100	0.8	1000A	200 times

Note：① Vs±XX%

Color Code

Part Number	Color Code 1	Color Code 2	Color Code 3
BK2XX00702	Black	Yellow	-
BK2XX01002	Red	-	-
BK2XX01102	Red	Red	-
BK2XX01502	Orange	-	-
BK2XX02002	Yellow	-	-
BK2XX02502	Green	-	-
BK2XX03002	Blue	-	-
BK2XX03502	Purple	-	-
BK2XX05002	Black	-	-
BK2XX07502	Brown	Green	Red

Test Methods and Results

<table>
<tr><th>Items</th><th>Test Method</th><th>Standard</th></tr>
<tr><td>DC Spark-over Voltage</td><td>Measure starting discharge voltage (Vs) by gradually increasing applied DC voltage. Test current is 0.5mA max. And the DC voltage ascends up within 100V/s(Vs＜1000V) or 500V/s(Vs≥1000V).</td><td rowspan="3">Meet specified value.</td></tr>
<tr><td>Insulation Resistance</td><td>Measure the insulation resistance across the terminal at regular voltage. But the test voltage doesn’t over the DC spark-over voltage.</td></tr>
<tr><td>Capacitance</td><td>Measure the electrostatic capacitance by applying a voltage of less than 6V (at 1KHz) between terminals.</td></tr>
<tr><td>Static Life</td><td>10KV with 1500pf condenser is discharged through 0Ω resistor. 200 times at an interval of 10sec.</td><td>｜Δ Vs/Vs｜≤30%
Characteristics of other items must meet the specified value.</td></tr>
<tr><td>Surge Current Capacity</td><td>The following impulse current for specified current applied ±5 times, each time interval 60 seconds. Thereafter, outer appearance shall be visually examined.
<table>
<tr><th>Type</th><th>Impulse current</th></tr>
<tr><td>Vs < 400V</td><td>1.2/50μs & 8/20μs, 1000A</td></tr>
<tr><td>Vs ≥ 400V</td><td>1.2/50μs & 8/20μs, 1000A, electrically connected with a resistor (1~2 Ω).</td></tr>
</table></td><td>No crack and no failures</td></tr>
<tr><td>Cold Resistance</td><td>Measurement after -40℃/1000 HRS & normal temperature/2 HRS.</td><td rowspan="4">Features are conformed to rated spec.</td></tr>
<tr><td>Heat Resistance</td><td>Measurement after 125℃/1000 HRS & normal temperature/2 HRS.</td></tr>
<tr><td>Humidity Resistance</td><td>Measurement after humidity 90~95℃(45℃) /1000 HRS & normal temperature/2 HRS.</td></tr>
<tr><td>Temperature Cycle</td><td>10 times repetition of cycle -40℃/30min →normal, temp/2 min →125℃/30min, measurement after normal temp/2 HRS.</td></tr>
<tr><td>Solder Ability</td><td>Apply flux and immerse in molten solder 230±5℃ for 3sec up to the point of 1.5mm from body. Check for solder adhesion.</td><td>Lead wire is evenly covered by solder.</td></tr>
<tr><td>Solder Heat</td><td>Measurement after lead wire is dipped up to the point of 1.5mm from body into 260±5℃ solder for 10sec.</td><td>Conformed to rated spec.</td></tr>
<tr><td>Pull Strength</td><td>Apply 0.5kg load for 10sec.</td><td rowspan="2">Lead shall not pull out to snap.</td></tr>
<tr><td>Flexural Strength</td><td>Bend lead wire at the point of 2mm from body under 0.25 load and back to its original point. Repeat 1 time.</td></tr>
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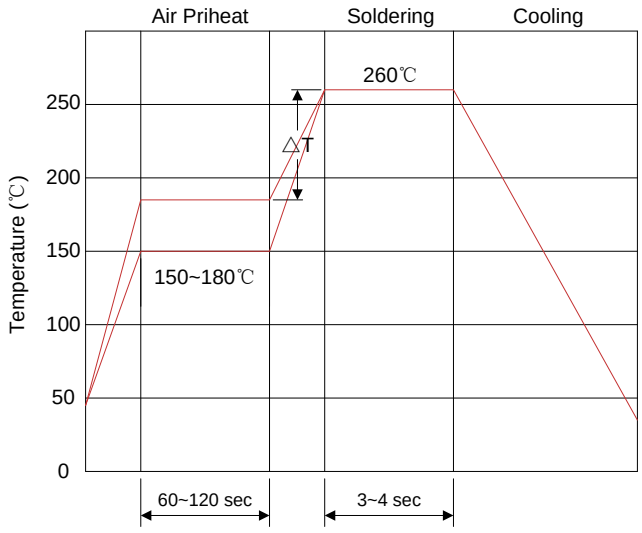
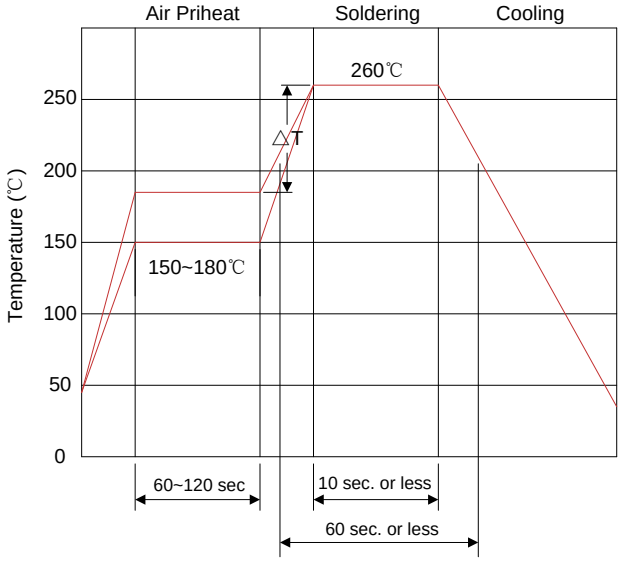
Recommended Soldering Conditions

Flow Soldering Conditions	Reflow Soldering Conditions
	

1) Time shown in the above figures is measured from the point when chip surface reaches temperature.
2) Temperature difference in high temperature part should be within 110℃.
3) After soldering, do not force cool, allow the parts to cool gradually.

Hand Soldering

Solder iron temperature: 350±5℃
Heating time: 3 seconds max.

General attention to soldering

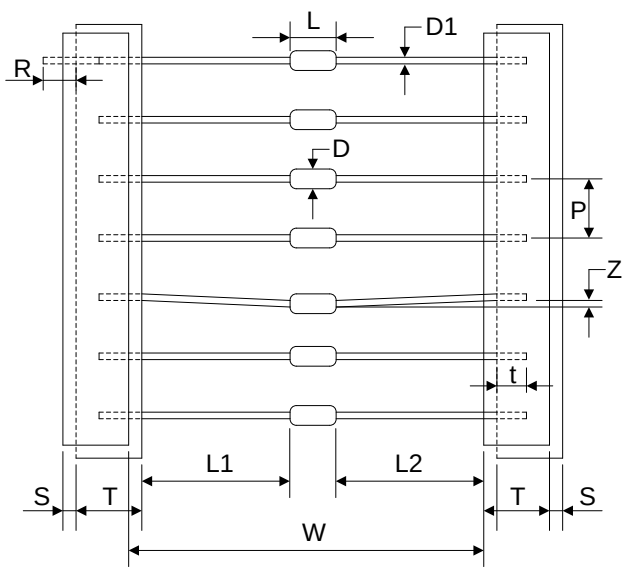
● High soldering temperatures and long soldering times can cause leaching of the termination, decrease in adherence strength, and the change of characteristic may occur.
● For soldering, please refer to the soldering curves above. However, please keep exposures to temperatures exceeding 200℃ to fewer than 50 seconds.
● Please use a mild flux (containing less than 0.2wt% Cl). Also, if the flux is water soluble, be sure to wash thoroughly to remove any residue from the underside of components that could affect resistance.

Cleaning

When using ultrasonic cleaning, the board may resonate if the output power is too high. Since this vibration can cause cracking or a decrease in the adherence of the termination, we recommend that you use the conditions below.
Frequency: 40kHz max.
Output power: 20W/liter
Cleaning time: 5 minutes max.

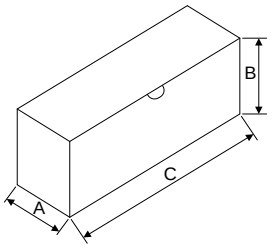
Packaging

Tape



Symbol	Dimension (mm)
W	52.0±1.5
P	5.0±0.5
L1-L2	1.0max.
T	6.0±1.0
Z	1.2max.
R	Terminals must not project from tape.
t	3.2max.
S	0.8max.
D	Φ3.1max.
D1	Φ0.5±0.05
L	4.8max.

Inner Box



A	74.0±5.0
B	77.0±5.0
C	252.0±5.0
Quantity: 2500PCS	